

TRUSTED CHIPS

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SECURE CONNECTIONS
FOR A SMARTER WORLD

EXTERNAL

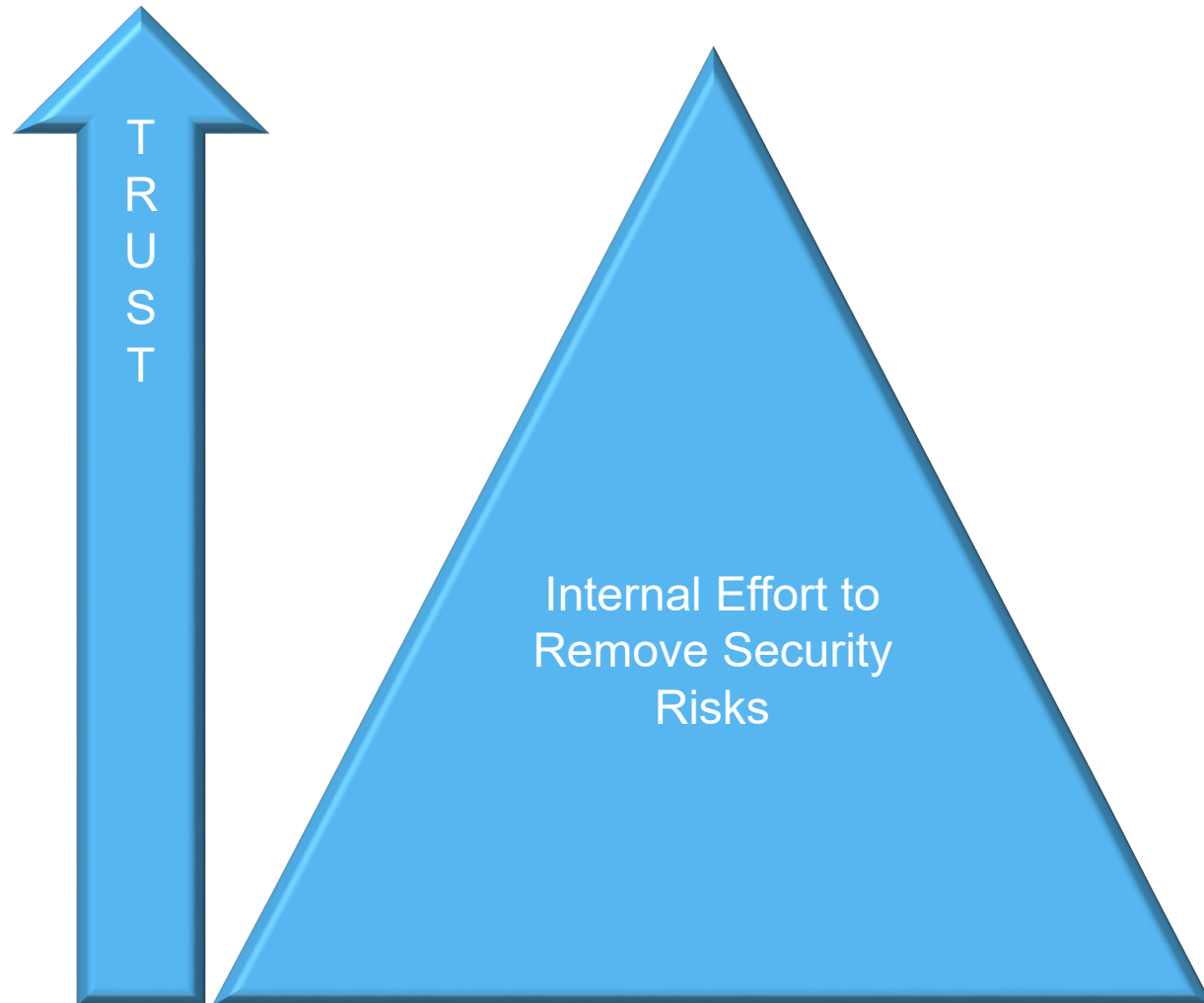
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TRUST IN A SUPPLY CHAIN PARTNER

Trust is mitigation of risk

If trust is low a company then has to spend internal effort to mitigate the risk



RISK MODEL FOR SEMICONDUCTORS AND COMMON MITIGATION

Back doors

- 3rd Party IP
- Malicious functionality Added during production

Bad Engineering

- Test Modes left unprotected
- Bad coding/design

Weak security

- Security as an add on
- Bypass of Security Features
- Spurious Security Claims
- Customer support on Security issues/Ownership

Cloning

- IP Theft
- Lack of digital ID

Trusted Supply Chains

Need to Know

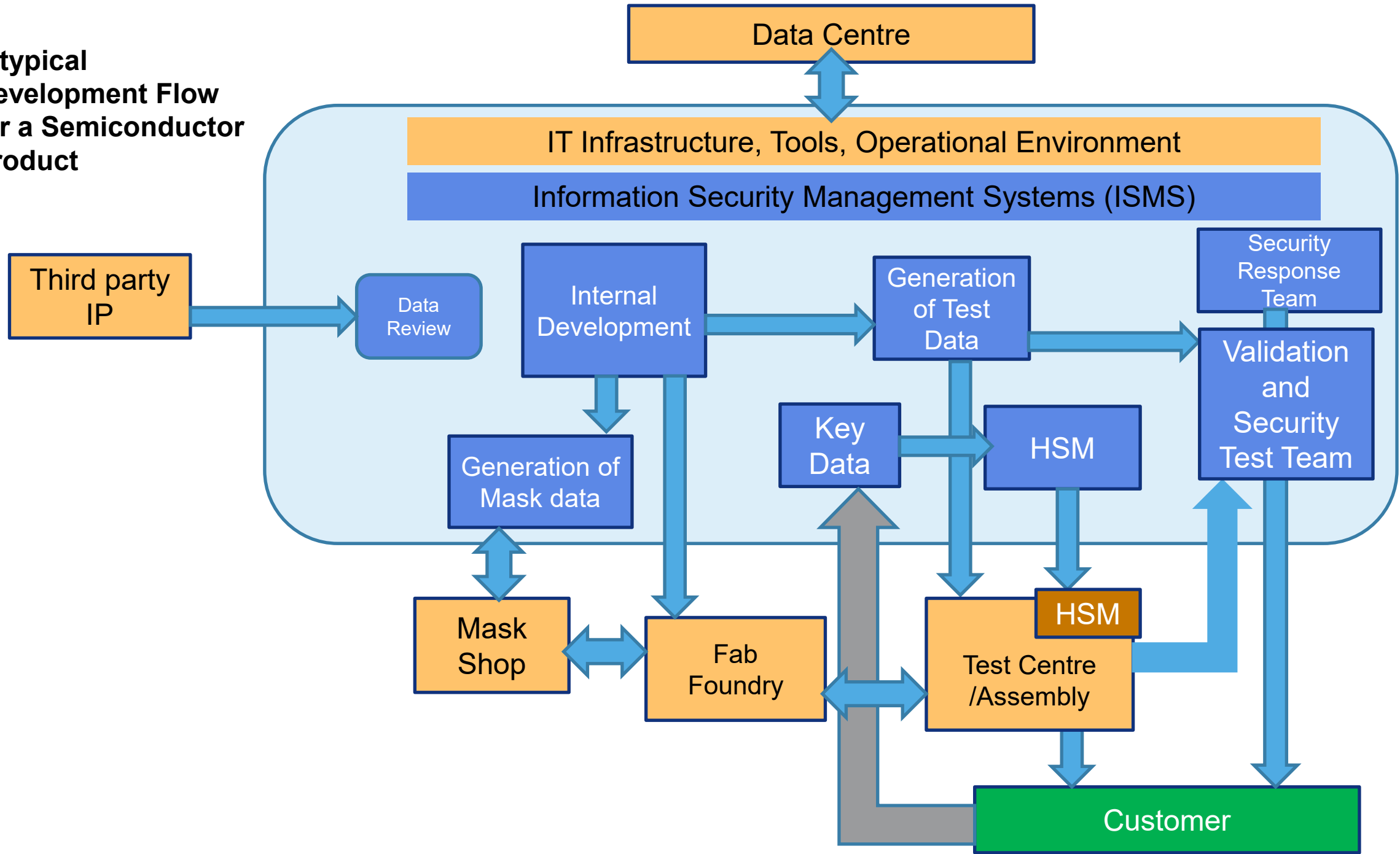
Security By Design

Security Testing and Verification

Strong Digital ID

Responsibility for Security Issues

A typical Development Flow for a Semiconductor Product



Risk Mitigation for External Partners

Data Centre

IT Infrastructure, Tools, Operational Environment

Third party IP

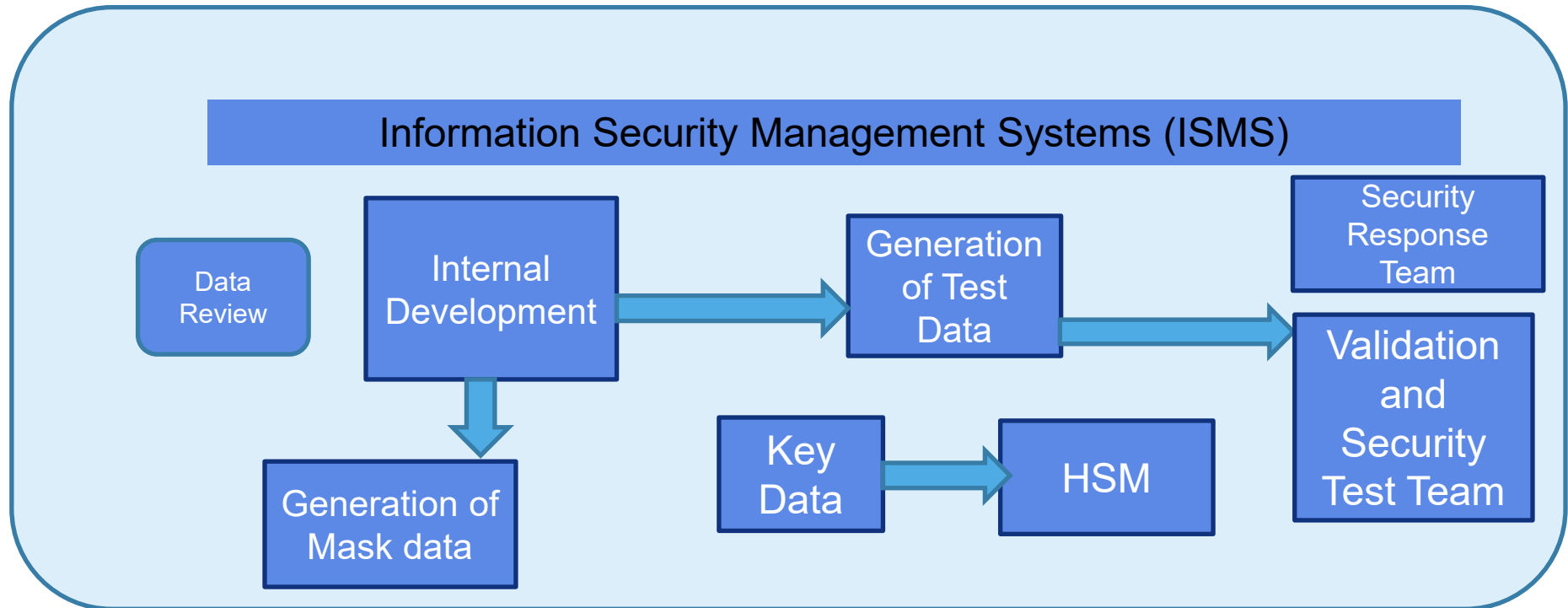
- External Suppliers Are Normally Security Audited by the Company Security Team
- They are often also audited and certified using The Common Criteria by the Governmental Cyber-agencies (ECCG)
- ISMS are usually certified using ISO 27001
- Third Party IP is audited for integrity

Mask Shop

Fab Foundry

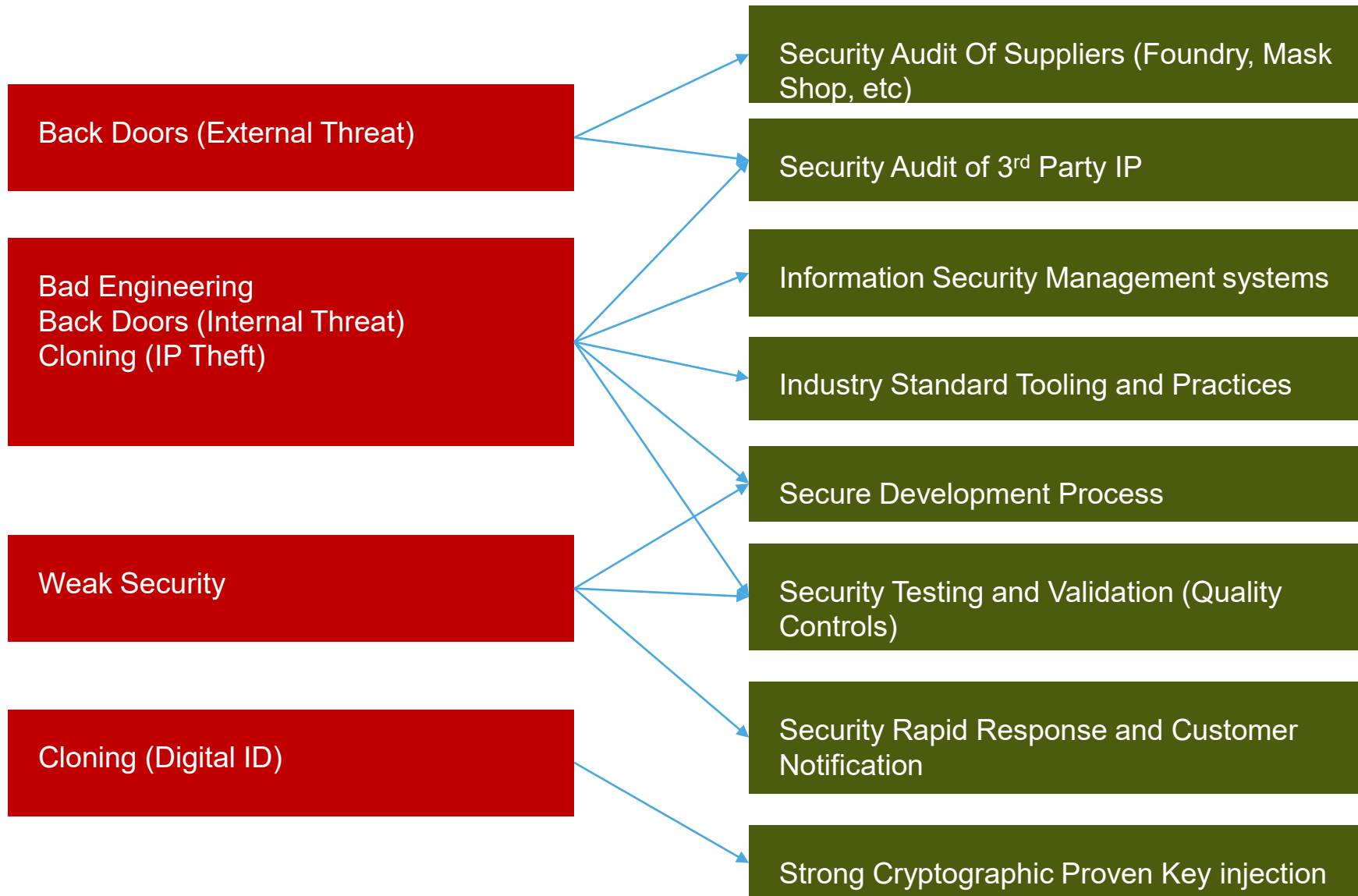
HSM
Test Centre /Assembly

Risk Mitigation for Company Internal Processes



- The Companies ISMS is certified using ISO27001
- Development Process and procedures and locations are certified using
 - Common Criteria
 - Process Certifications (e.g. ISO 21434, IEC 62443)
- The chip has a strong digital identity injected use strong cryptographic key material

THREATS VS KEY RISK MITIGATION





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